

FRED Pt® Gen 4 Doubler Ultrafast Diode, 400 A (INT-A-PAK Power Modules)



PRIMARY CHARACTERISTICS					
V_R	600 V				
I _{F(AV)} at T _C	375 A at 50 °C				
t _{rr} at 25 °C	159 ns				
Туре	Modules - diode, FRED Pt®				
Package	INT-A-PAK				
Circuit configuration	Diode doubler circuit				

FEATURES

- Gen 4 FRED Pt® dices technology
- Ultrasoft reverse recovery characteristics
- Low I_{RRM} and reverse recovery charge
- · Very low forward voltage drop
- 175 °C operating junction temperature
- UL approved file E78996 for application with maximum case temperature up to 140 °C
- Large creepage distances
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Gen 4 FRED Pt technology, state of the art, ultra low V_F , soft switching optimized for IGBT F/W diode.

The minimized conduction loss, optimized storage charge, and low recovery current, minimized the switching losses and reduce the over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	V_R		600	V	
Continuous forward current	I _F	T _C = 25 °C	540		
		T _C = 80 °C	400	A	
Single pulse forward current	I _{FSM}	t_p = 10 ms, 50 Hz, sine half wave, initial T_J = 175 °C	4140	A	
Maximum power dissipation	Б	T _C = 25 °C	1153	W	
	P_{D}	T _C = 90 °C	653	- vv	
Operating junction temperature range	T _J		-40 to +175	°C	
Storage temperature range	T _{Stg}		-40 to +150	·	
RMS insulation voltage	V _{INS}	50 Hz, circuit to base, all terminals shorted, t = 1 s	3500	V	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	I _R = 500 μA	600	-	-	
Forward voltage drop		I _F = 200 A -	1.28	-		
	V_{FM}	I _F = 400 A	-	1.51	1.67	V
		I _F = 200 A, T _J = 150 °C	-	1.04	-	
		I _F = 400 A, T _J = 150 °C	-	1.35	-	
Reverse leakage current	I	V _R = 600 V	1	12	1	μΑ
	I _{RM}	T _J = 150 °C, V _R = 600 V	-	2.2	-	mA



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t _{rr}	T _J = 25 °C	I _F = 150 A dl/dt = 200 A/µs V _R = 400 V	-	159	1	ns
		T _J = 125 °C		-	320	-	
Peak recovery current	I _{rr}	T _J = 25 °C		-	14	-	А
		T _J = 125 °C		-	32	-	
Reverse recovery charge	Q _{rr}	T _J = 25 °C		-	0.9	-	μC
		T _J = 125 °C		-	4.3	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER SY		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum therm junction to case	,	R _{thJC}	DC operation	0.147		
Typical thermal resistance, case to heat sink		R _{thCS}	Mounting surface, flat, smooth and greased	0.035	K/W	
Mounting	to heat sink		A mounting compound is recommended and the			
torque ± 10 % busbar			torque should be rechecked after a period of 3 hours to allow the spread of the compound.	4 to 6	Nm	
Approximate we	iaht			200	g	
Approximate weight				7.1	OZ.	
Case style				INT-A-PAK		

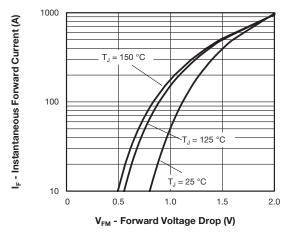


Fig. 1 - Typical Forward Voltage Drop Characteristics

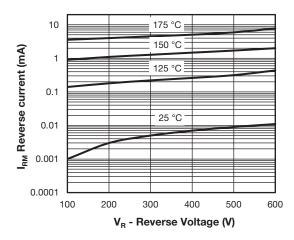


Fig. 2 - Typical Value of Reverse Current vs. Reverse Voltage



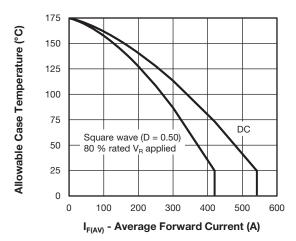


Fig. 3 - Maximum Allowable Case Temperature vs. Average Forward Current

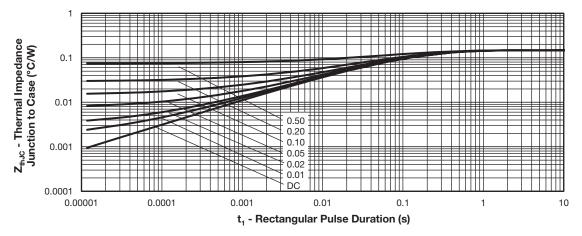


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

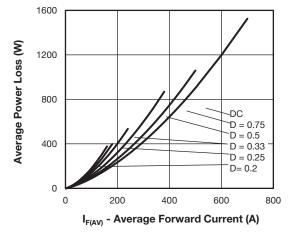


Fig. 5 - Forward Power Loss Characteristics

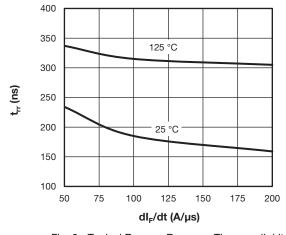


Fig. 6 - Typical Reverse Recovery Time vs. dI_F/dt $I_{FM} = 150 \text{ A}, V_R = 400 \text{ V}$



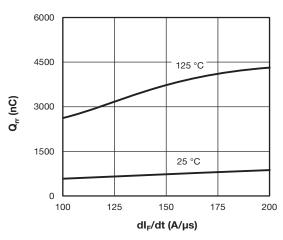


Fig. 7 - Typical Reverse Recovery Charge vs. dI_F/dt $I_{FM} = 150 \text{ A}, V_R = 400 \text{ V}$

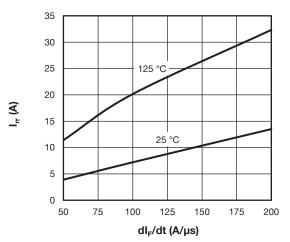
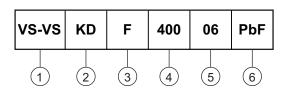


Fig. 8 - Typical Reverse Recovery Current vs. dI_F/dt $I_{FM} = 150 \text{ A}, V_R = 400 \text{ V}$

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

- Circuit configuration: KD = doubler circuit

F = FRED Pt[®] ultrafast diode

- Current rating (400 = 400 A)

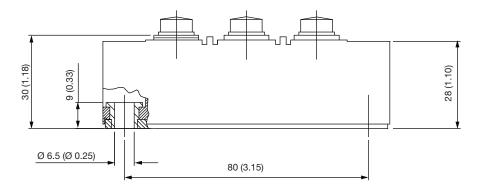
5 - Voltage rating (06 = 600 V)

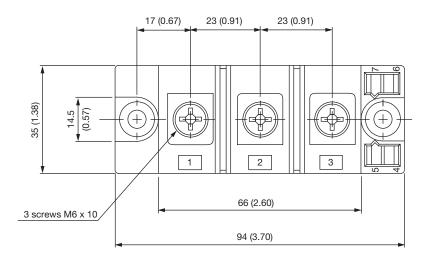
6 - PbF = lead (Pb)-free

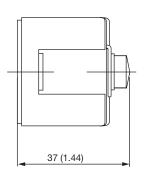
CIRCUIT CONFIGURATION					
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING			
Diode doubler circuit	KD	KD reversed polarity			



DIMENSIONS in millimeters (inches)



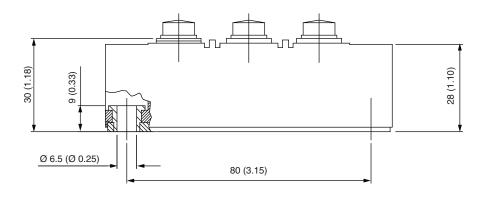


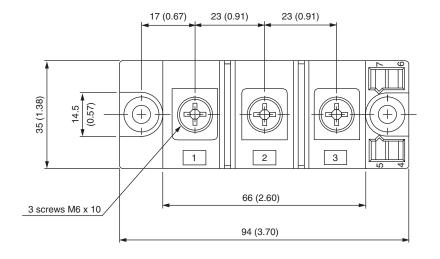


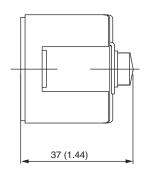


INT-A-PAK DBC

DIMENSIONS in millimeters (inches)









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